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CLAIMS

1. A patch package characterized by
comprising a laminated packaging material with a
saturation hygroscopicity of $2-30 \text{ g/m}^2$ under atmosphere
5 conditions with a temperature of 25°C and a relative
humidity of 75%, wherein a hygroscopic material layer
composed of a first resin containing 20-40 wt% of an
inorganic filler is situated between a moisture-
permeable material layer composed of a second resin and
10 having a moisture permeability of $40-120 \text{ g/m}^2/\text{day}$ and a
screen material layer which blocks penetration of
moisture and light, and by

being shaped into a pouch with said moisture-
permeable material layer on the inside.

15 2. A patch package according to claim 1, wherein
said first resin and said second resin are low density
polyethylene, and

said screen material layer comprises a metal foil
and a high density polyethylene layer.

20 3. A patch package according to claim 2, wherein
the thickness of said hygroscopic material layer is 20-
40 μm ,

the thickness of said moisture-permeable material
layer is 5-15 μm ,

25 the thickness of said high-density polyethylene
layer composing said screen material layer is 10-30 μm

the thickness of said metal foil composing said screen material layer is 5-15 μm .

the heat seal strength is from 1.0 kg/25 mm to 5.0 kg/25 mm.

4, and

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